3M Scotch-Weld[™] TE-200 Thermoset Adhesive

Product Data Sheet

			Updated : June 2005 Supersedes : November 1997
Product Description	3M Scotch-Weld [™] TE-200 Adhesive is a one- component, moisture curing, urethane adhesive that is applied warm.	This low viscosity adhesive has a long open time and is ideal for bonding wood. Yields thin glue lines.	
	• 100% solids	One component	Very high strength bonds to wood
	 Long open time 	Low viscosity	Rapid rate of strength build-up
	 Bonds selected plastics 		

Physical Properties Application 250 °F 121°C (Uncured) Temperature Not for specification purposes 3,000 cps (mPa.s) Viscosity (at 250°F - 121°C) White/Off-White Colour (solid) **Open Time²** 4 minutes Set Time³ 2 minutes 8.9 Density molten lbs/gallon Shelf Life 6 months from date of despatch by 3M when stored in the original carton at 21°C (70°F) & 50 % Relative Humidity ¹ Measured on Brookfield viscometer with Thermosel using spindle no. 27. ² The bonding range of a 3.2mm/1/8" bead of molten adhesive on a non-metallic substrate. ³ The minimum amount of time required between when the bond is made and when it will support a 3.6 N/mm² tensile load.

Physical Properties (Cured) Not for specification purposes	Shore D Hardness ¹	60	
	Modulus ²	67 N/mm² (9,700 psi)	
	Tensile Strength at Break ²	28 N/mm² (4,000 psi)	
	Elongation at Break ²	625 %	
	¹ Measured on 2.3 - 2.8mm ² ASTM D 638, Die C, measu days at 77°F (25°C) / 50% R	ured on 0.28 - 0.30 mm thick films cured for a minimu	um of 7

Performance Characteristics

Not for specification purposes

Note: The following technical information and data should be considered

representative or typical only and should not be used for specification purposes.

Overlap Shear Strength

Tested at 73°F (23°C)

Substrate	МРа	psi
Maple FRP Polycarbonate Polyacrylic Polystyrene ABS PVC	13.45 24.14 15.17* 8.62* 4.48* 8.62* 14.83*	1,950 3,500 2,200* 1,250* 650* 1,250* 2,150*
Substrate Failure		1

Overlap Shear Strength

Tested at 180°F (82°C)

Substrate	MPa	psi
Maple FRP	4.28 10.69	620 1550
Substrate Failure		

180° Peel Strength

Tested at 73°F (23°C)

Substrate	N/10mm	piw
FRP	140*	80*
Polycarbonate	158*	90*
Polyacrylic	80*	46*
Polystyrene	16	9
ABS	140*	80*
PVC	140*	80*
Aluminium	NT	NT
Glass	NT	NT

¹ Cotton duck failed during test.

NT : Not Tested

Substrate Failure

			Date : June 2005 TE-200 Thermoset Adhesive
Directions for Use	Apply to clean, dry surfaces. Remove oil, grease and other contaminants by wiping with isopropyl alcohol*. For fibre reinforced plastics and other materials that are often contaminated with mold release agents, it is recommended that the surface be solvent wiped, abraded and solvent wiped*. After heating to 250°F (121°C), apply adequate amount of Scotch-Weld™ Adhesive to one of the substrates to be bonded. Join the substrates within the recommended open time and hold/fixture the bonded part until the adhesive has adequately set.	Note: Do not bond metal or glass to itself or each other because cure will not occur due to the low moisture vapour permeation rate of the substrate. Cure Time: The cure rate will vary depending on air temperature, relative humidity, substrate type and bond line thickness. Cure rate is more rapid on wood (moisture-rich substrate) than on plastic.	Clean Up: Allow product to solidify. Remove uncured waxy material (usually within the first 20 minutes after application) by scraping with a putty knife or similar tool. For cured material, remove by cutting or sanding. Do not use heat or flame to remove adhesive. * Note: When using solvents, extinguish all ignition sources and observe manufacturers' directions and precautions for handling such materials.
Dispensing Equipment	Cartridge dispensing equipment: 300ml aluminium cartridges of 3M Scotch-Weld [™] Adhesive should only be dispensed with the 3M Scotch-Weld [™] Adhesive Applicator or the 3M Scotch-Weld [™] II Adhesive Applicator. The adhesive should be preheated for 45 minutes in the 3M Scotch-Weld [™] Adhesive Preheater or the	Bulk dispensing equipment: Bulk containers of adhesive can only be dispensed through equipment specifically designed for use with hot melt polyurethane reactive adhesives (PUR's). All equipment must be used in strict accordance with the recommendations of the equipment manufacturer.	Important: Adhesive heated at application temperature for more than 16 hours should be discarded.
	3M Scotch-Weld [™] II Applicator prior to dispensing.		

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Values presented have been determined by standard test methods and are average values not to be used for specification purposes. Our recommendations on the use of our products are based on tests believed to be reliable but we would ask that you conduct your own tests to determine their suitability for your applications. This is because 3M cannot accept any responsibility or liability direct or consequential for loss or damage caused as a result of our recommendations.



Industrial Adhesives & Tapes Division

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